# 6-1761614-5 ACTIVE

#### STEP-Z

TE Internal #: 6-1761614-5

PCB Mount Header, Vertical, Board-to-Board, 200 Position, 1.3 mm [.051 in] Centerline, Partially Shrouded, Gold, Surface Mount -

Solder Ball

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Connectors > PCB Connectors > PCB Headers & Receptacles



PCB Connector Assembly Type: PCB Mount Header

PCB Mount Orientation: Vertical
Connector System: Board-to-Board

Number of Positions: 200
Number of Rows: 2

#### **Features**

#### **Product Type Features**

| PCB Connector Assembly Type       | PCB Mount Header      |
|-----------------------------------|-----------------------|
| Connector System                  | Board-to-Board        |
| Header Type                       | Partially Shrouded    |
| Sealable                          | No                    |
| Connector & Contact Terminates To | Printed Circuit Board |

#### **Configuration Features**

| Stackable                    | Yes      |
|------------------------------|----------|
| PCB Mount Orientation        | Vertical |
| Number of Positions          | 200      |
| Number of Rows               | 2        |
| Board-to-Board Configuration | Parallel |

#### **Electrical Characteristics**

| Dielectric Withstanding Voltage (Max) | 500 VAC |
|---------------------------------------|---------|
| Insulation Resistance                 | 18 ΜΩ   |
| Operating Voltage                     | 48 VAC  |

### **Body Features**

| Primary Product Color | Natural |
|-----------------------|---------|
|-----------------------|---------|

#### **Contact Features**



| Contact Layout                                 | Matrix                         |
|--|--------------------------------|
| Mating Tab Width                               | 1 mm[.04 in]                   |
| Mating Tab Thickness                           | .2 mm[.008 in]                 |
| Contact Shape & Form                           | Dual Beam, Single Beam, Square |
| PCB Contact Termination Area Plating Material  | Tin-Silver                     |
| Contact Base Material                          | Copper Alloy                   |
| Contact Mating Area Plating Material           | Gold                           |
| Contact Mating Area Plating Material Thickness | .76 μm[29.9212 μin]            |
| Contact Type                                   | Tab                            |
| Contact Current Rating (Max)                   | 1 A                            |
| Termination Features                           |                                |
| Termination Method to Printed Circuit Board    | Surface Mount - Solder Ball    |
| Mechanical Attachment                          |                                |
| Mating Retention                               | With                           |
| Mating Alignment                               | Without                        |
| PCB Mount Retention                            | Without                        |
| PCB Mount Alignment                            | Without                        |
| Connector Mounting Type                        | Board Mount                    |
| Housing Features                               |                                |
| Centerline (Pitch)                             | 1.3 mm[.051 in]                |
| Housing Material                               | Thermoplastic                  |
| Dimensions                                     |                                |
| Connector Height                               | 15.95 mm[.627 in]              |
| Row-to-Row Spacing                             | 2 mm[.079 in]                  |
| Stack Height                                   | 20 mm, 26 mm, 30 mm[1.181 in]  |
| PCB Thickness (Recommended)                    | 1.57 mm[.8 in]                 |
| Jsage Conditions                               |                                |
| Operating Temperature Range                    | 0 - 100 °C[32 - 212 °F]        |
| Operation/Application                          |                                |
| Assembly Process Feature                       | None                           |
| Circuit Application                            | Power & Signal                 |
| ndustry Standards                              |                                |



| UL Flammability Rating | UL 94V-0 |
|------------------------|----------|
| Packaging Features     |          |
| Packaging Quantity     | 25       |
| Packaging Type         | Tray     |

#### **Product Compliance**

For compliance documentation, visit the product page on TE.com>

| EU RoHS Directive 2011/65/EU                  | Compliant  |
|---|--|
| EU ELV Directive 2000/53/EC                   | Compliant  |
| China RoHS 2 Directive MIIT Order No 32, 2016 | No Restricted Materials Above Threshold  |
| EU REACH Regulation (EC) No. 1907/2006        | Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JAN 2023 (233) Does not contain REACH SVHC |
| Halogen Content                               | Low Halogen - Br, Cl, F, I < 900 ppm per<br>homogenous material. Also BFR/CFR/PVC<br>Free                                |
| Solder Process Capability                     | Reflow solder capable to 260°C   |

#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

## Compatible Parts



















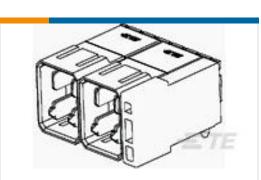
# Customers Also Bought



TE Part #2180850-1
IMP,PWR,3PR,HDR,L-HLD,1X,797-1,N
/A

TE Part #2328508-2 CAGE ASSY W/ HS 1X2 QSFP-DD

TE Part #3-5353652-9 .5FHP08H,440,B,GIG,30/Sn,HT,NSYes TE Part #4-6600333-3
MBXL VERT HDR 2ACP+24S+2ACP



TE Part #2180851-1
IMP,PWR,3PR,HDR,R-HLD,1X,797-1,N
/A

TE Part #2304921-3
ZSFP+ 1X8 CAGE ASSEMBLY, PRESS-FIT

TE Part #2317416-3
OSFP 1X1 CAGE ASSMBLY

TE Part #2361706-1 CAGE ASSY, QSFP -DD 1X1, CUST HS

TE Part #2384280-1

RCPT CONN R/A SMT 76 POSN QSFPDD WSHRS

### **Documents**

**Product Drawings** 

STEP-Z PLUG 15MM 200P LF ST

English

#### **CAD Files**

Customer View Model ENG\_CVM\_CVM\_6-1761614-5\_B.2d\_dxf.zip

English

3D PDF



3D

**Customer View Model** 

ENG\_CVM\_CVM\_6-1761614-5\_B.3d\_igs.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_6-1761614-5\_B.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages

STEP-Z Interconnection System

English

**Product Specifications** 

**Application Specification** 

English